

岱煒科技股份有限公司
ASSEM TECHNOLOGY CO.,LTD.
SPECIFICATION FOR APPROVAL

PART NAME : 0.4PH 0.8H Ultra-Slim BTB

ASE5SXX10(Socket)

PART NO. : ASE6HXX10 (Header)

APP. DATE : 2013.03.18

MANUFACTURER SIGNATURE

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PRODUCT NAME: 0.4mm pitch mating height 0.8mm Ultra-Slim Board-to-Board Connector

REV: A

ISSUE DATE: 2011-11-01

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SPECIFICATION OF PRODUCT

0.4mm pitch mating height 0.8mm Ultra-Slim Board-to-Board Connector

1. Scope:

This specification covers the requirements of product performance, and test methods provisions of 0.4mm pitch mating height 0.8mm Ultra-Slim Board-to-Board connector.

2. Applicable documents:

The following document from a part of this specification to the extent specified herein. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

3. Requirements:

3.1. Materials:

Contact: Copper Alloy. Gold Plating.

Housing: Heat Resistance Plastic.

4. Manufacture Place :

No.17, Minquan ST., Tucheng Dist., New Taipei City 23679, TAIWAN

5. Electrical Performance:

No.	Items	Requirements	Test Procedures
5.1	Rated current	0.3A per pin (All pins can carry Max.5A)	-
5.2	Rated voltage	30V AC/DC	-
5.3	Breakdown Voltage	150V AC for 1minute (Initial stage)	In accordance with method of JIS C5402. Test with 1mA current and 250VDC for 1 minute
5.4	Insulation resistance	1000MΩ Min.(initial)	
5.5	Contact resistance	80mΩ Max.	

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6. Environmental Performance:

No.	Items	Requirements	Test Procedures
6.1	Ambient Temperature	-55°C ~ 85°C	No freezing or condensation
6.2	Storage Temperature	-55°C ~ 85°C ..(Products only) -40°C ~ 50°C (Packaging structure)	No freezing or condensation
6.3	Thermal shock	5 cycles Contact resistance.80mΩ Max Insulation resistance 100MΩ Min.	In accordance with method MIL-STD-202G method 107G. -55±3°C (30min) → 25±3°C (5min) → 85±3°C (30min) → 25±3°C (5min) → -55±3°C (30min) for 5 cycles.
6.4	Humidity	Contact resistance.80mΩ Max Insulation resistance 100MΩ Min.	In accordance with MIL-STD-1344A method 1002 The specimens shall be placed in a chamber and subjected to a relative humidity of 90 to 95 % and temperature of 40±2°C for 120 hours
6.5	Salt spray	Contact resistance.80mΩ Max Insulation resistance 100MΩ Min.	In accordance with method MIL-STD-1344A method 1001. The specimens subjected to the chamber temperature of 35±2°C exposure to a salt spray from 5±1% solution for 24 hours.
6.6	H ₂ S resistance	Contact resistance.80mΩ Max	Bath temperature 40±2°C Gas concentration 3±1ppm Humidity 75 to 80%R.H. for 48hours.

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7. Mechanical Performance:

No.	Items	Requirements	Test Procedures
7.1	Insertion force	1.2Nf. max. per pin	Mate applicable header or socket at the speed of 5±1 mm/min.
7.2	Withdrawal force	0.2Nf. min. per pin	Mate applicable header or socket at the speed of 5±1 mm/min.
7.3	Vibration	Appearance no damage, loose part nor crack. Contact Resistance :80mΩMAX. Discontinuity : 1μs MAX.	In accordance with method MIL-STD-202G method 201 condition A, all contacts shall be connected in series and DC 5mA shall be applied. Wave form : Sine wave. Frequency :10~55~10Hz/1min. Amplitude : 1.5mm. Orientation : X,Y,Z (3 axes). Duration : 2hrs./axis.
7.4	Shock	Appearance no damage, loose part nor crack. Contact Resistance :80mΩMAX. Discontinuity : 1μs MAX.	In accordance with method MIL-STD-202G method 213B condition A. DC 100mA shall be applied. MAX acceleration: 50G. Wave form : Half sine wave. Orientation : X,Y,Z (3 axes). Duration : 11ms./axis. Times: 3 times/axis.
7.5	Resistance to soldering heat	No loose contacts nor damage	1. Hand soldering: Soldering time: 3 ± 0.5 second. Solder temperature: 350 ± 5°C. 2. Reflow: In accordance with method MIL-STD-202 method 210 condition K.
7.6	Durability	.. Contact Resistance :80mΩMAX.	Mate applicable header or socket , insert and withdrawal at the speed rate of 5 ± 1 mm/min. up to 50 times

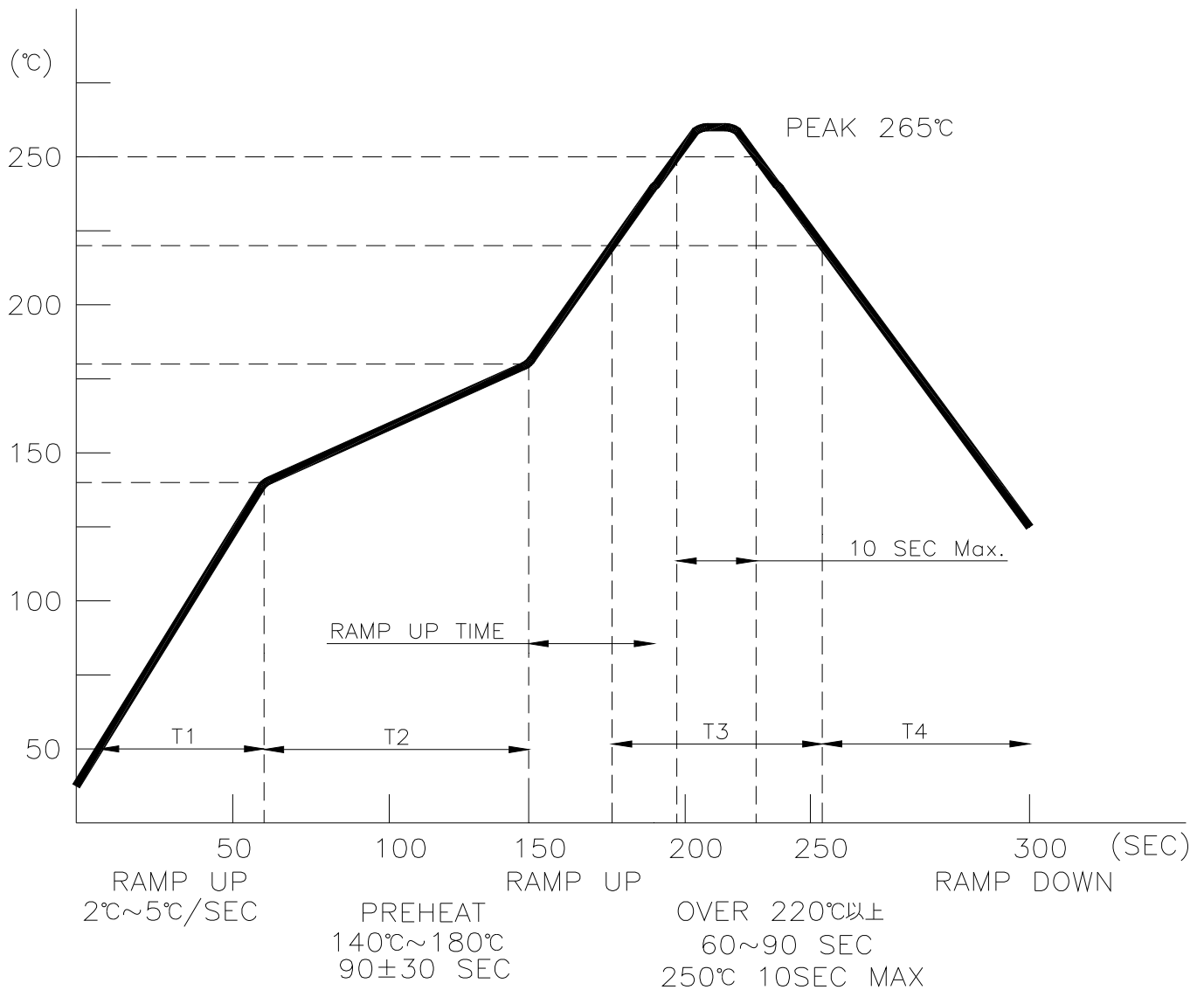
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8. RECOMMENDED IR REFLOW PROFILE



T1:	Temperature Ramp Up Rate	2°C~5°C/SEC
T2:	Preheat: 140°C~180°C	90±30 SEC
T3:	Time Over 220°C	60~90 SEC
T4:	Ramp Down Rate During Cooling	4°C~7°C/SEC
	Peak Temperature	265°C Max

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II. MATERIAL REFERENCE TABLE

Parts Name	General Name	Model No.	Heat Resistance Level	UL Card No.
Housing	LCP	E471i(d)	UL94V-0	E106764
Socket Terminal	Phosphor Borne	C5210R-EH	—	—
Header Terminal	Phosphor Borne	C5191-EH	---	---

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III. MATERIAL CERTIFICATE OF HOUSING

General Properties of E471i

table1-1 General Properties (ISO)

Item	Unit	Test Method	Standard, For SMT
			E471i
			Low warpage, Standard
Color			VF2201/BK210P
ISO(JIS)quality-of-the-material display:		ISO11469 (JIS K6999)	>LCP-(GF+MD)35<
Density	g/cm ³	ISO 1183	1.67
Water absorption (23°C,24hrs)	%	ISO 62	0.03
Tensile strength	MPa	ASTM D638	140
Tensile elongation	%	ASTM D638	2.3
Flexural strength	MPa	ISO 178	195
Flexural modulus	MPa	ISO 178	13,500
Flexural strain	%	ISO 178	2.5
Charpy impact strength (notched)	kJ/m ²	ISO 179/1eA	20
Temperature of deflection under load (1.8MPa)	°C	ISO 75-1,2	265
Temperature of deflection under load (0.45MPa)	°C	ISO 75-1,2	285
Dielectric breakdown strength (1mmt)	kV/mm	IEC 60243-1	47
Dielectric breakdown strength (3mmt)	kV/mm	IEC 60243-1	25
Volume resistivity	Ω·cm	IEC 60093	2 × 10 ¹⁶
Volume resistivity (Our standard)	Ω·cm		-
Relative permittivity (1kHz)		IEC 60250	4.3
Relative permittivity (1MHz)		IEC 60250	3.8
Dielectric dissipation factor (1kHz)		IEC 60250	0.02
Dielectric dissipation factor (1MHz)		IEC 60250	0.03
Tracking resistance (CTI)	V	IEC 60112	150
Arc resistance	s		176
Mold Shrinkage (80×80×1mmt, Flow direction, Inj. pressure 60MPa)	%	Our standard	0.06
Mold Shrinkage (80×80×1mmt, Trans-direction, Inj. pressure60MPa)	%	Our standard	0.43
Mold Shrinkage (80×80×1mmt, Flow direction, Inj. pressure79MPa)	%	Our standard	-
Mold Shrinkage (80×80×1mmt, Trans direction, Inj pressure 79MPa)	%	Our standard	-
Rockwell hardness	M(Scale)	ISO2039-2	65
Flammability		UL94	V-0
The yellow card File No.			E106764
Appropriate List number of Ministerial Ordinance for Export Trade Control			Item 16 of Appendix -1

All figures in the table are the typical values of the material and not the minimum values of the material specifications.

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1. E471i的一般物性

表 1-1 一般物性(ISO)

项 目	单 位	试验方法	高耐热, 高流动
			E471i
			低翘曲性
密度	g/cm ³	ISO 1183	1.67
拉伸强度*	MPa	ASTM D638	140
拉伸率*	%	ASTM D638	2.3
弯曲强度	MPa	ISO 178	195
弯曲模量	MPa	ISO 178	13500
弯曲应变	%	ISO 178	2.5
简支梁冲击强度(有缺口)	kJ/m ²	ISO 179/1eA	20
负荷变形温度(1.8MPa)	°C	ISO 75-1,2	265
成型收缩率(80口×1mmt, 流动方向, 注射压力60MPa)	%		0.06
成型收缩率(80口×1mmt, 垂直方向, 注射压力60MPa)	%		0.43
成型收缩率(80口×1mmt, 流动方向, 注射压力79MPa)	%		-
成型收缩率(80口×1mmt, 垂直方向, 注射压力79MPa)	%		-
体积电阻率	Ω · cm	IEC 60093	1.0×10 ¹⁶
表面电阻率	Ω	IEC 60093	1.0×10 ¹⁶
介电常数(1kHz)		IEC 60250	4.3
介电常数(1MHz)		IEC 60250	3.8
介电常数(10GHz)			3.7
介电损耗角正切(1kHz)		IEC 60250	0.018
介电损耗角正切(1MHz)		IEC 60250	0.032
介电损耗角正切(10GHz)			0.007
绝缘破坏强度(1mmt)	kV/mm	IEC 60243-1	47
绝缘破坏强度(3mmt)	kV/mm	IEC 60243-1	25
耐导电径迹	CTI	IEC 60112	150
耐电弧性	s		176
阻燃性		UL94	V-0

以上数值为材料的代表性测试值、并非该规格材料的最低值。

*1)有关UL (Underwriters Laboratories Inc.) 的认定值、请参照UL发行的黄卡 (File No.E106764) 。

*2)本品级受以日本国外汇管理及外国贸易法为依据的出口贸易管理条例表中的第1条第16项的制约。

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Component - Plastics

E106764

POLYPLASTICS CO LTD

VECTRA DIV, 18-1 KONAN 2-CHOME, MINATO-KU, TOKYO 108-8280 JP

E471i(d)

Liquid Crystal Polymer (LCP), "VECTRA", furnished as pellets

Color	Min Thk (mm)	Flame Class	HWI	HAI	RTI Elec	RTI Imp	RTI Str
NC, BK	0.1	V-0	-	-	130	130	130
	0.8	V-0	-	-	130	130	130
ALL	1.5	V-0	-	-	130	130	130
	3.0	V-0	-	-	130	130	130

Comparative Tracking Index (CTI): **3**

Dimensional Stability (%): -

High-Voltage Arc Tracking Rate
(HVTR): -

High Volt, Low Current Arc Resis (D495): -

Dielectric Strength (kV/mm): -

Volume Resistivity (10^x ohm-cm): -

(d) - Virgin and regrind up to 50% by weight incl., have the same basic material characteristics in NC and BK with a minimum thickness of 0.80mm.

ANSI/UL 94 small-scale test data does not pertain to building materials, furnishings and related contents. ANSI/UL 94 small-scale test data is intended solely for determining the flammability of plastic materials used in the components and parts of end-product devices and appliances, where the acceptability of the combination is determined by UL.

Report Date: 2000-01-31

Last Revised: 2010-04-26

Underwriters Laboratories Inc®



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IV. MATERIAL CERTIFICATE OF HEADER TERMINAL

試 験 成 績 書 INSPECTION CERTIFICATE

J X 日 鉱 日 石 金 属
KURAMI WORKS, JX NIPPON

需要家 殿
 CUSTOMER
 扱先 台湾日鉱金属
 MESSRS.
 製品名 C5191R--EH
 PRODUCTS
 寸法 0.08 X 305 X L
 SIZE
 規格
 SPECIFICATION
 化学成分
 CHEMICAL COMPOSITIONS

発行日 2013年04月16日 0009
 DATE OF ISSUE
 納品書番号 19012
 DELIVERY SHEET NO.
 注文番号 TLC13-241
 CONTRACT NO.
 オーダー番号 809993
 ORDER NO.

神奈川県高座郡寒川町倉九
 3 KURAMI, SAMUKAWA-MACHI, KOUZA-GUN,
 KANAGAWA-KEN 〒253-0101
 TEL. 0467-75-0611

品質保証課長
 MANAGER OF QUALITY
 ASSURANCE SECTION



規格 SPECIFICATION	Zn %	Sn %	P %	Fe %	Pb %	Cu+Sn+P %							
製造番号 MIN		5.5	0.03			99.5							
LOT NO. MAX	0.20	7.0	0.35	0.10	0.02								
13012	0.006	5.81	0.1	0.001	0.004	99.98							

質量 MASS (KG)
1,093.0

機 械 的 お よ び 物 理 的 性 質 MECHANICAL AND PHYSICAL PROPERTIES

規格 SPECIFICATION	引張強さ TENSILE STRENGTH N/mm ²	伸 び ELONGATION %	硬 さ HARDNESS HV											
製造番号 MIN			200											
LOT NO. MAX			220											
13012	717	5.3	220											

寸法検査 DIMENSIONAL INSPECTIONS	GOOD
外観検査 SURFACE INSPECTIONS	GOOD
備考 REMARKS	

この製品は品質管理計画に基づき製造され、検査・試験を行ない、規格に合格したことを証明する。
 WE HEREBY CERTIFY THAT THE PRODUCTS DESCRIBED HEREIN HAVE BEEN MANUFACTURED, INSPECTED AND TESTED IN ACCORDANCE WITH THE SPECIFICATION AND Q. C. PROGRAM.

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MATERIAL CERTIFICATE OF SOCKET TERMINAL

P.002/003

(FAX)

2013/05/28 08:55 mono

試 験 成 績 書

INSPECTION CERTIFICATE

J X 日 敏 日 石 金 属 株 式 会 社 倉 見 工 場
KURAMI WORKS, JX NIPPON MINING & METALS CORPORATION

需 要 家
CUSTOMER
披 先 台 湾 日 敏 金 属
MESSRS.
製 品 名 C5210R-EH (HP)
PRODUCTS
寸 法 0.08 X 150Z X L
SIZE
規 格
SPECIFICATION

發 行 日 2013年02月06日
DATE OF ISSUE
納 品 番 番 号 42984
DELIVERY SHRET NO.
注 文 番 号 TLC12-647
CONTRACT NO.
オ ー ー 号 01
ORDER NO.

0005 神奈川県高座郡寒川町倉見3番地
3 KURAMI, SAMUKAWA-MACHI, KOHZA-GUN,
KANAGAWA-KEN 〒253-0101
TEL.0467-75-0611

品 質 保 証 課 長
MANAGER OF QUALITY
ASSURANCE SECTION

Y. Oaei

化 学 成 分 CHEMICAL COMPOSITIONS

規 格 SPECIFICATION	Zn %	Sn %	P %	Fe %	Pb %	Cu+Sn+P %									質 量 MASS (KG)
製造番号 MIN		7.0	0.03			99.7									
LOT NO. MAX	0.20	9.0	0.35	0.10	0.02										
80347	0.01	7.68	0.12	0.001	0.002	99.90									1,234.00

機 械 的 お よ び 物 理 的 性 質 MECHANICAL AND PHYSICAL PROPERTIES

規 格 SPECIFICATION	引 張 強 さ TENSILE STRENGTH N/mm ²	伸 び : ASTM ELONGATION (ASTM) %	耐 力 PROOF STRESS N/mm ²	硬 さ HARDNESS HV	90° 曲 試 験 (L) 90° BEND TEST (L)	90° 曲 試 験 (T) 90° BEND TEST (T)								寸 法 検 査 DIMENSIONAL INSPECTIONS	GOOD
製造番号 MIN	685	11.0	590	210										外 観 検 査 SURFACE INSPECTIONS	GOOD
LOT NO. MAX	785			280	R=TX0.5	R=TX1.0								備 考 REMARKS.	
80347	748	19.0	711	240	GOOD	GOOD									

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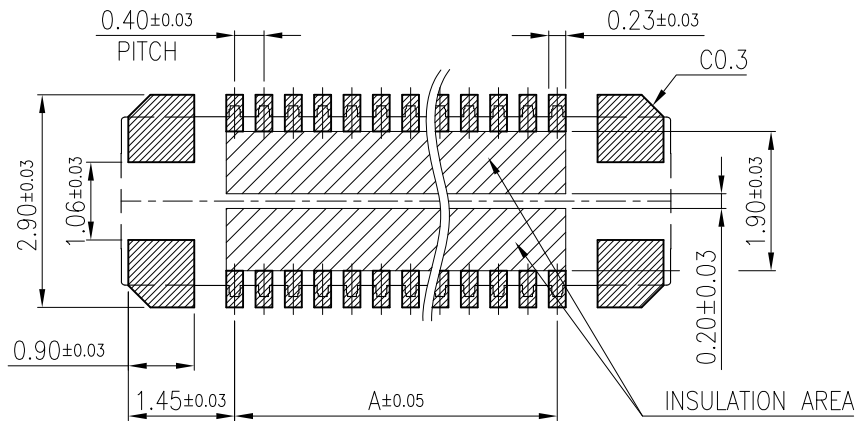
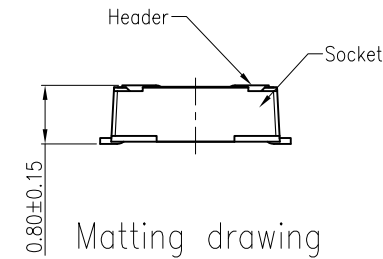
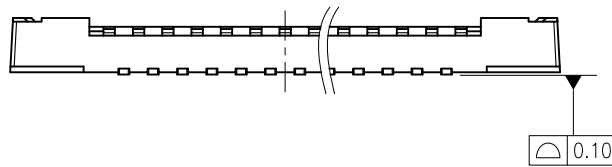
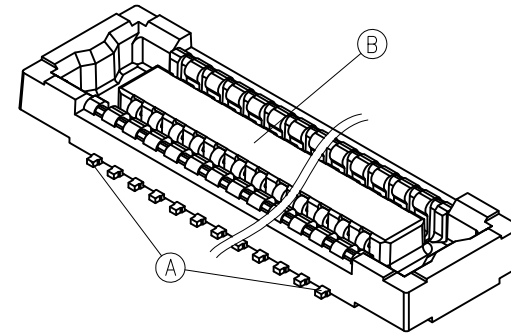
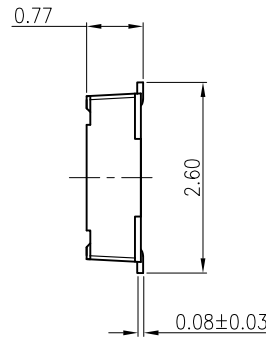
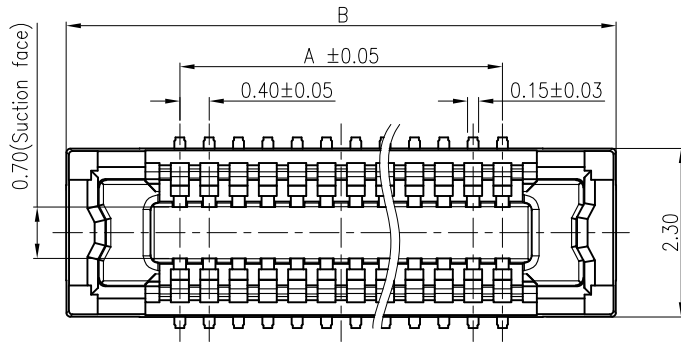
CUSTOMER

REV.	DCN/ECN	DESCRIPTION	DR.	DATE	APPD.

Dimension table (mm)

※ : Mass Production

No. of contacts	Dimension	
	A	B
※ 10	1.60	4.70
12	2.00	5.10
14	2.40	5.50
※ 16	2.80	5.90
※ 18	3.20	6.30
※ 20	3.60	6.70
※ 22	4.00	7.10
※ 24	4.40	7.50
※ 26	4.80	7.90
※ 30	5.60	8.70
※ 34	6.40	9.50
※ 36	6.80	9.90
※ 40	7.60	10.70
※ 44	8.40	11.50
※ 50	9.60	12.70
※ 60	11.60	14.70
※ 70	13.60	16.70



Recommended PC board pattern
(mounting pad layout)

NOTES :

1. Part No. : ASE 5S XX 10

No. OF SERIES

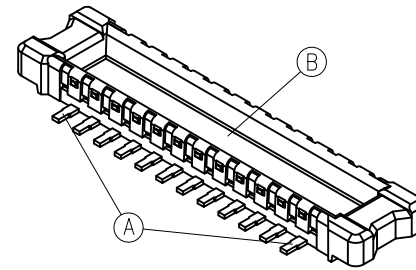
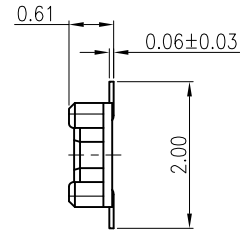
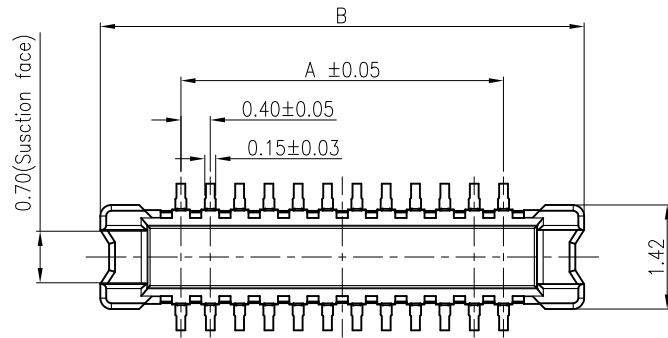
5S : SOCKET

Contacts No.

②	HOUSING	1	HIGH TEMP.PLASTIC	BLACK	UL94-V0
①	TERMINAL	-	COPPER ALLOY	GOLD	-
ITEM	DESCRIPTIONS	QTY.	MATERIAL	FINISH	REMARKS
General tolerance		P/N		TITLE	
DIMENSION		ASE5SXX10		0.4mm Pitch BOARD TO BOARD MATED HEIGHT 0.80mm SOCKET CONNECTOR	
ANGLES		Original Date		D/N	
. ± 0.4		2011/5/30		ASE5SXX10	
.X ± 0.3		DR.	PHIL	SCALE	UNIT
.XX ± 0.15		CHK.	JERRY	10:1	mm
.XXX ± 0.1		APPD.	STING	REV.	SHEET
				J	1/1
				ATC ASSEM TECHNOLOGY CO., LTD.	

CUSTOMER

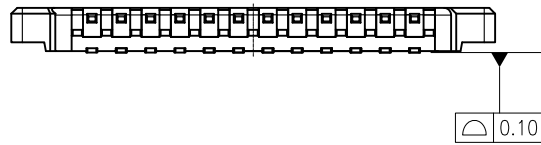
REV.	DCN/ECN	DESCRIPTION	DR.	DATE	APPD.



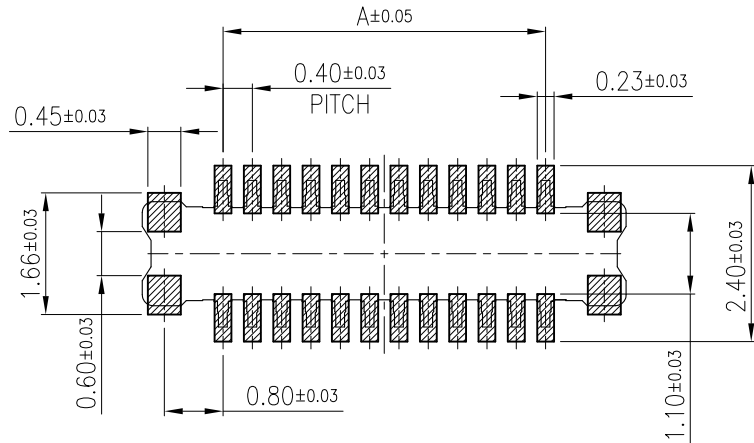
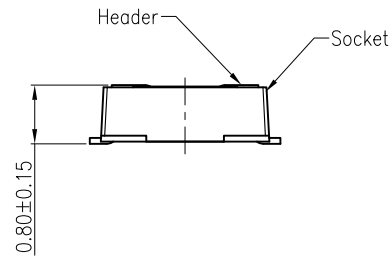
Dimension table (mm)

※ : Mass Production

No. of contacts	Dimension	
	A	B
※ 10	1.60	3.80
12	2.00	4.20
14	2.40	4.60
※ 16	2.80	5.00
※ 18	3.20	5.40
※ 20	3.60	5.80
※ 22	4.00	6.20
※ 24	4.40	6.60
※ 26	4.80	7.00
※ 30	5.60	7.80
※ 34	6.40	8.60
※ 36	6.80	9.00
※ 40	7.60	9.80
※ 44	8.40	10.60



Matting drawing

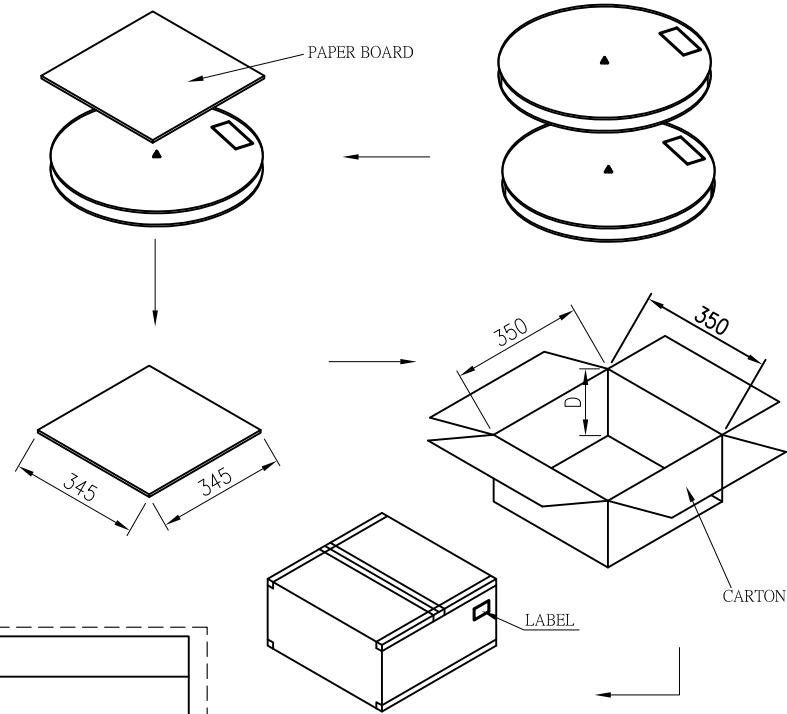
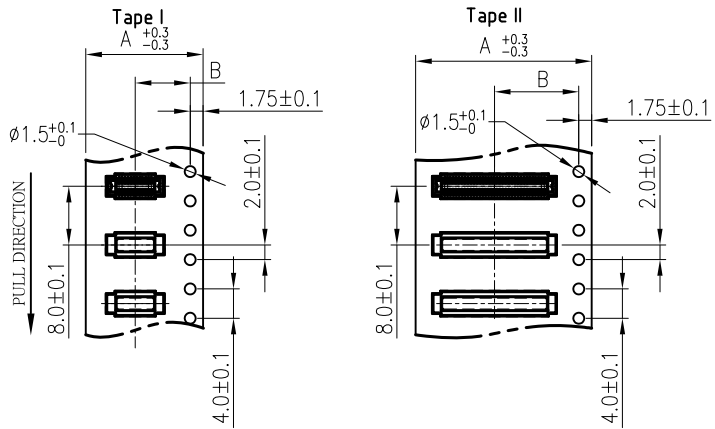


Recommended PC board pattern
(mounting pad layout)

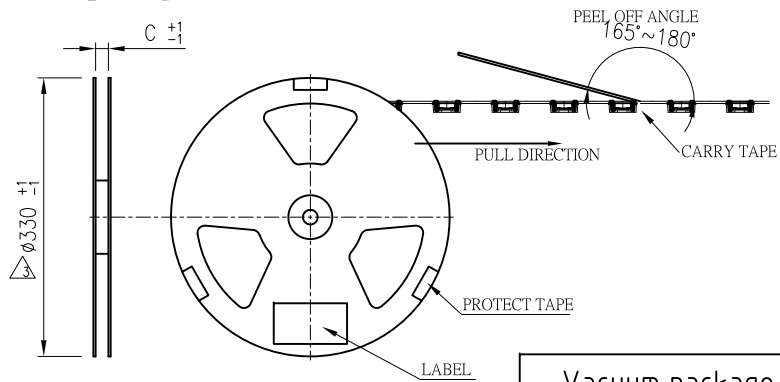
NOTES : 1. Part No. : ASE 6H XX 10
 No. OF SERIES
 6H : HEADER Contacts No.

ⓑ	Housing	XX	HIGH TEMP. PLASTIC	BLACK	UL94-V0
Ⓐ	Terminal	-	COPPER ALLOY	GOLD	-
ITEM	DESCRIPTIONS	QTY.	MATERIAL	FINISH	REMARKS
General tolerance		P/N ASE6HXX10		TITLE 0.4mm Pitch BOARD TO BOARD MATED HEIGHT 0.80mm HEADER CONNECTOR	
DIMENSION		ANGLES		D/N ASE6HXX10	
. ± 0.4		X° ± 5°		SCALE 10:1	
.X ± 0.3		X.X° ± 3°		UNIT mm	
.XX ± 0.15		APPD. STING		REV. 1	
.XXX ± 0.1		Original Date 2011/5/30		SHEET 1/1	
				ATC ASSEM TECHNOLOGY CO., LTD.	

REV.	DCN/ECN	DESCRIPTION	DR.	DATE	APPD.
3	ECN13002	更正輪盤尺寸	PHIL	2013/01/25	JERRY
4	ECN14023	修改上帶預留尺寸	PHIL	2014/08/08	STING
5	ECN15001	修改紙箱高度	PHIL	2015/01/07	STING

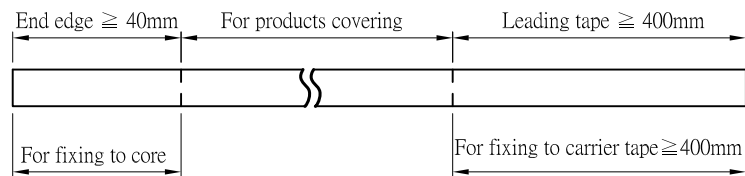


Reel package (EIAJ ET - 7200B) MATERIAL : PS



Vacuum package
 1. Vacuum the air out of the bag.
 2. Prevent the dust involve.

Cover Tape MATERIAL : PET



CARTON LABEL

Description	
Part No.	
Quantity	
N. W	
G. W	

REEL LABEL

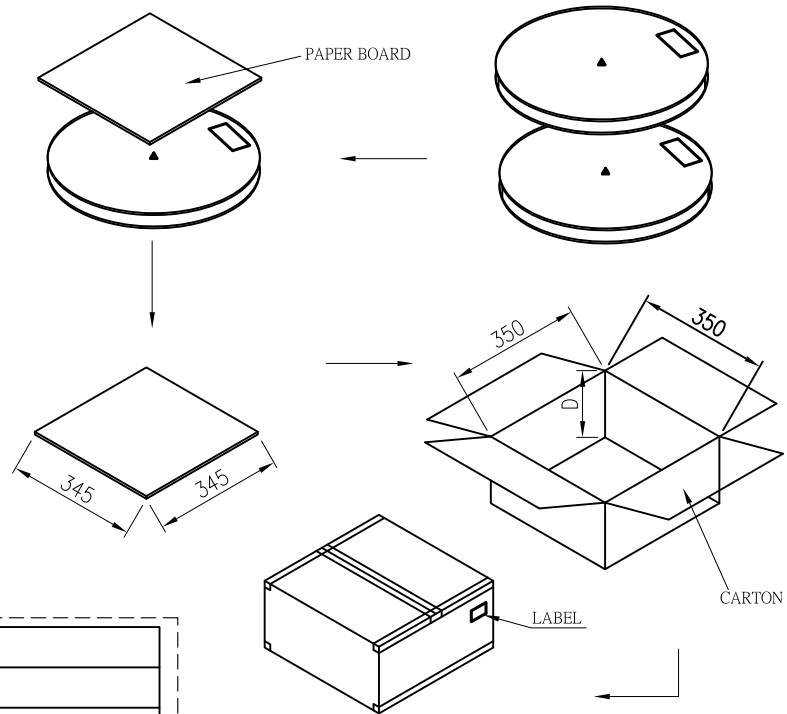
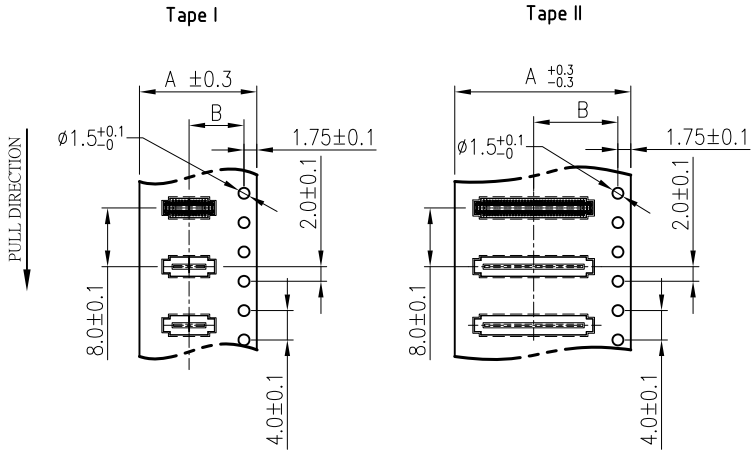
Assem Technology Co., Ltd

Description	
Part No.	
Quantity	
Date Code	

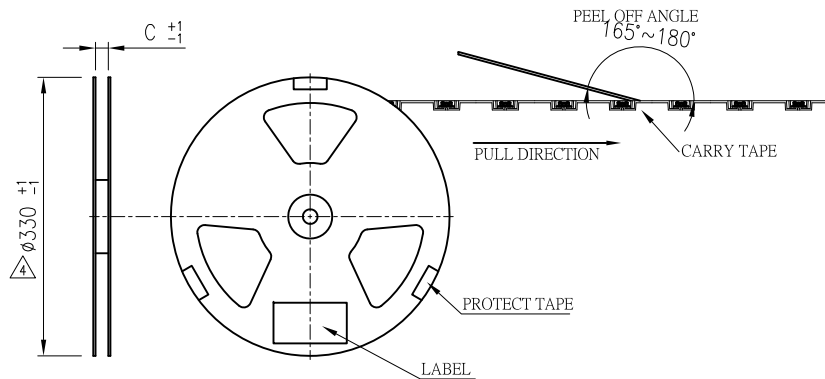
70	ASES70W								
60	ASES60W								
50	ASES50W								
44	ASES44W								
40	ASES40W	Tape II	24.0	11.5	25.4		5	25000 pcs	180
36	ASES36W								
34	ASES34W								
30	ASES30W								
26	ASES26W								
24	ASES24W						5000 pcs		
22	ASES22W								
20	ASES20W								
18	ASES18W	Tape I	16.0	7.5	17.4		5	25000 pcs	145
16	ASES16W								
14	ASES14W								
12	ASES12W								
10	ASES10W								
Pin	P / N	Type of taping	Dim A	Dim B	Dim C	Reel	Reels	Carton	Dim D

General tolerance		DRAWING NO.		TITLE	
DIMENSION	ANGLES	1C051-XX0XX-000		0.4mm Pitch BOARD TO BOARD MATED HIGHT 0.80mm SOCKET CONNECTOR PACKING SPEC.	
.X ± 0.35	X° ± 5°	DR.	PHIL	Original Date	2011/9/8
.XX ± 0.25	X.X° ± 3°	CHK.	JERRY		
.XXX ± 0.15		APPD.	STING	SCALE	UNIT
				1:1	mm
				REV.	SHEET
					1/1
				ATC ASSEM TECHNOLOGY CO., LTD.	

REV.	DCN/ECN	DESCRIPTION	DR.	DATE	APPD.
4	ECN13002	更正輪盤尺寸	PHIL	2013/01/25	JERRY
5	ECN14023	修改上帶預留尺寸	PHIL	2014/08/08	STING
6	ECN15001	修改紙箱高度	PHIL	2015/01/07	STING

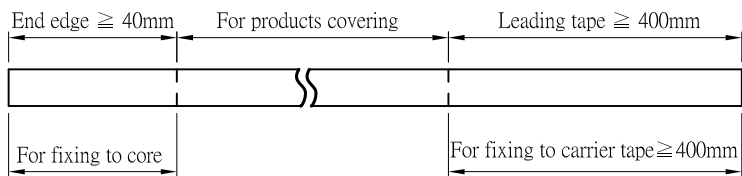


Reel package (EIAJ ET - 7200B) MATERIAL : PS



Vacuum package
 1. Vacuum the air out of the bag.
 2. Prevent the dust involve.

Cover Tape MATERIAL : PET



CARTON LABEL

Description	
Part No.	
Quantity	
N. W	
G. W	

REEL LABEL

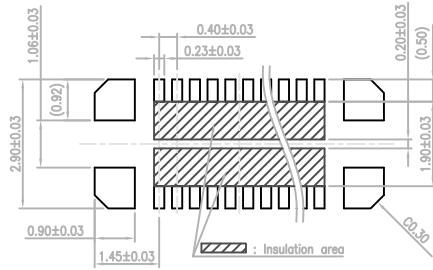
Assem Technology Co., Ltd

Description	
Part No.	
Quantity	
Date Code	

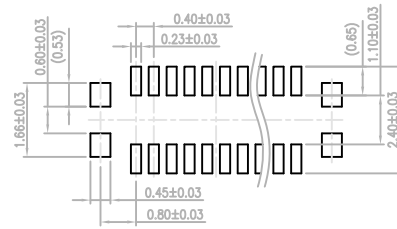
70	ASEM7000								
60	ASEM6000								
50	ASEM5000								
44	ASEM4400								
40	ASEM4000	Tape II	24.0	11.5	25.4		5	25000 pcs	180
36	ASEM3600								
34	ASEM3400								
30	ASEM3000								
26	ASEM2600								
24	ASEM2400								
22	ASEM2200							5000 pcs	
20	ASEM2000								
18	ASEM1800	Tape I	16.0	7.5	17.4		5	25000 pcs	145
16	ASEM1600								
14	ASEM1400								
12	ASEM1200								
10	ASEM1000								
PM	P / N	Type of Taping	DIM A	DIM B	DIM C	Reel	Reels	Carton	DIM D

General tolerance		DRAWING NO.		TITLE	
DIMENSION	ANGLES	1C052-XX0XX-000		0.4mm Pitch BOARD TO BOARD MATED HIGHT 0.80mm HEADER CONNECTOR PACKING SPEC.	
.X ± 0.35	X° ± 5°	DR.	PHIL	Original Date	2011/9/8
.XX ± 0.25	X.X° ± 3°	CHK.	JERRY	SCALE	UNIT
.XXX ± 0.15		APPD.	STING	1:1	mm
				REV.	SHEET
					1/1
				ATC ASSEM TECHNOLOGY CO., LTD.	

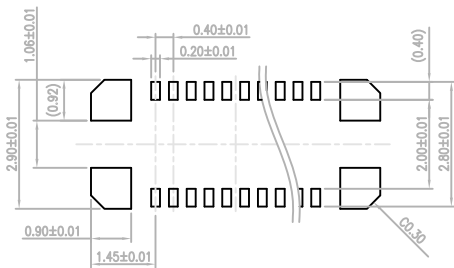
Socket
Recommended PC board pattern
(Mount pad arrangement pattern)



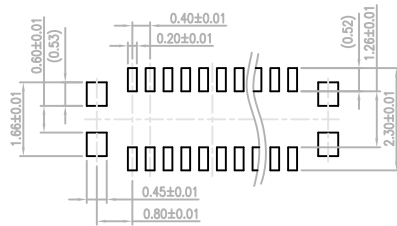
Header
Recommended PC board pattern
(Mount pad arrangement pattern)



Recommended metal mask pattern
metal mask thickness : Here, 120 μm
(Terminal portion opening area ratio : 70%)
(Metal portion opening area ratio : 100%)



Recommended metal mask pattern
metal mask thickness : Here, 120 μm
(Terminal portion opening area ratio : 70%)
(Metal portion opening area ratio : 100%)



TITLE: 0.4mm Pitch B TO B CONNECTOR

Date : 2012.01.10

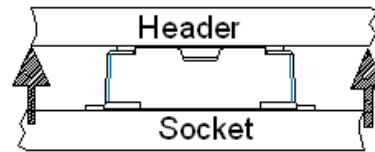
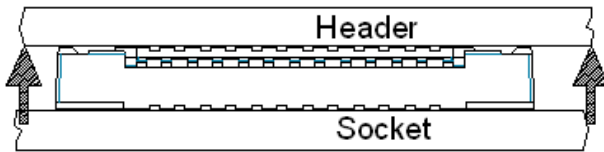
REV

A

拔出方式:

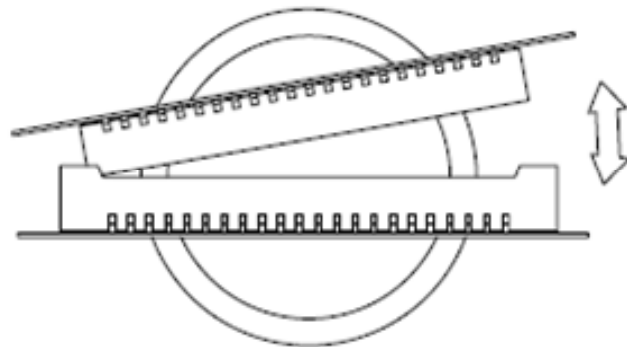
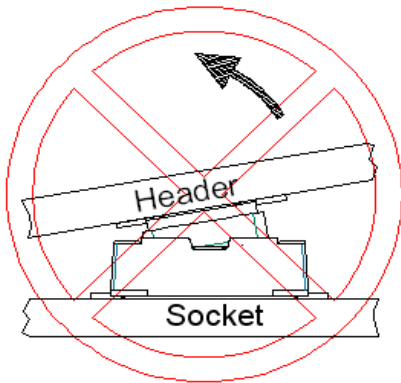
平均施力平行拔出

Lift even, keeping both connectors parallel to each other.



長邊方向避免單邊拔出，短邊方向可單邊拔出

Lift from short-side is acceptable. Do not attempt to lift the connectors from Long-side.



TITLE: 0.4mm Pitch B TO B CONNECTOR

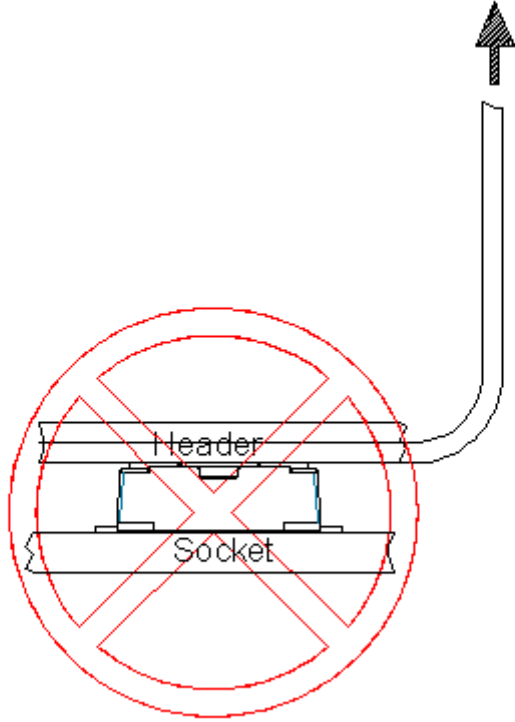
Date : 2012.01.10

REV

A

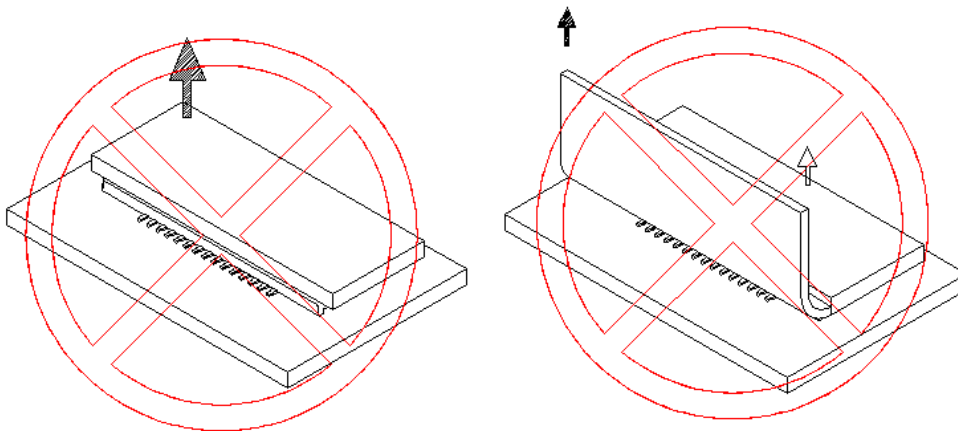
避免以拉軟性電路板(FPC)方式分離

Do not attempt to un-mate the connectors by pulling the FPC.



避免單一角落單獨施力

Do not attempt to start the un-mating of the connectors from one side or corner.



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